

# CHENZHUO LI

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## EDUCATION

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<i>Apr 2021 - Present</i>	Doctoral Student in Mechanics <i>École Polytechnique Fédérale de Lausanne</i>	<i>Lausanne, Switzerland</i>
	<ul style="list-style-type: none"> <li>• Thesis title: Stability of low-velocity cracks near an engineered inclusion</li> <li>• Advisor: Prof. John Kolinski [website]</li> </ul>	
<i>Sep 2014 - Jun 2018</i>	B.S. in Flying Vehicle Power Engineering <i>Beihang University</i>	<i>Beijing, China</i>
	<ul style="list-style-type: none"> <li>• GPA: 3.7/4.0</li> </ul>	
<i>Sep 2017 – Feb 2018</i>	Undergraduate International Exchange Program <i>Polytechnic University of Milan</i>	<i>Milan, Italy</i>

## RESEARCH EXPERIENCE

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<i>Apr 2021 - Present</i>	Ph.D. candidate in Mechanics <i>École Polytechnique Fédérale de Lausanne</i>	<i>Lausanne, Switzerland</i>
	<ul style="list-style-type: none"> <li>• Fracture mechanics, soft materials, 3D microscopy, particle tracking</li> <li>• Advisor: Prof. John Kolinski [website]</li> </ul>	
<i>Oct 2018 – Jan 2021</i>	Research Assistant <i>Beihang University</i>	<i>Beijing, China</i>
	<ul style="list-style-type: none"> <li>• 2D &amp; 3D digital image correlation</li> <li>• Principle Investigator: Prof. Bing Pan [website]</li> </ul>	
<i>Jun 2018 – Sep 2018</i>	Experiment Assistant <i>Center of Space Exploration (Chongqing University)</i>	<i>Beijing, China</i>
<i>Sep 2017 – Jun 2018</i>	Undergraduate researcher <i>Beihang University</i>	<i>Beijing, China</i>
	<ul style="list-style-type: none"> <li>• Finite element analysis on porous materials</li> <li>• Principle Investigator: Prof. Zaoyang Guo [website]</li> </ul>	
<i>May 2015 – Oct 2016</i>	Team Leader and APP developer <i>Beihang University</i>	<i>Beijing, China</i>

## PUBLICATIONS

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[Google scholar link]

\* Equal contribution, † Corresponding author

13. T. Yuan, C. Li, J. Kolinski, E. Amstad†, “Electrostatically reinforced double network granular hydrogels”, *Advanced Science*, 12, 2412566 (2025) [link]
12. C. Li, D. Zubko, D. Delespaul, J. Kolinski†, “3D characterization of kinematic fields and poroelastic swelling near the tip of a propagating crack in a hydrogel”, *International Journal of Fracture*, online, 1–15 (2024) [link]
11. X. Wei, C. Li, C. McCarthy, J. Kolinski†, “Complexity of crack front geometry enhances toughness of brittle solids”, *Nature Physics*, 20, 1–6 (2024) [link]
10. T. Benkley \*, C. Li\*, J. Kolinski†, “Estimation of the Deformation Gradient Tensor by Particle Tracking Near a Free Boundary with Quantified Error”, *Experimental Mechanics*, 63(7), 1255–1270 (2023) [link]
9. C. Li\*, X. Wei\*, M. Wang, M. Adda-Bedia, J. Kolinski†, “Crack tip kinematics reveal the process zone structure in brittle hydrogel fracture”, *Journal of the Mechanics and Physics of Solids*, 178,

- 105330 (2023) [link]
8. K. Zhu\*, C. Li\*, B. Pan†, “Rapid and Repeatable Fluorescent Speckle Pattern Fabrication Using a Handheld Inkjet Printer”, *Experimental Mechanics*, 62(4), 627–637 (2022) [link]
  7. X. Zhang\*, C. Li\*, L. Yu, B. Pan†, “Heatwave distortion correction using an improved reference sample compensation method and multispectral digital image correlation”, *Applied Optics*, 60(13), 3716–3723 (2021) [link]
  6. B. Dong, C. Li, B. Pan†, “Fluorescent 2D Digital Image Correlation With Built-in Coaxial Illumination for Deformation Measurement in Space-constrained Scenarios”, *Experimental Mechanics*, 61, 653–661 (2021) [link]
  5. B. Fu\*, C. Li\*, B. Dong†, P. Ou†, “Enhanced Digital Gradient Sensing Using Backlight Digital Speckle Target”, *Sensors*, 20(22), 6557 (2020) [link]
  4. C. Li, H. Luo, B. Pan†, “High-throughput measurement of coefficient of thermal expansion using a high-resolution digital single-lens reflex camera and digital image correlation”, *Review of Scientific Instruments*, 91(10), 105106 (2020) [link]
  3. B. Dong\*, C. Li\*, B. Pan†, “Fluorescent digital image correlation applied for macroscale deformation measurement”, *Applied Physics Letters*, 117(4), 044101 (2020) [link]
  2. B. Dong\*, C. Li\*, B. Pan†, “Ultrasensitive video extensometer using single-camera dual field-of-view telecentric imaging system”, *Optics letters*, 44(18), 4499–4502 (2019) [Link]
  1. C. Li\*, B. Dong\*, B. Pan†, “A flexible and easy-to-implement single-camera microscopic 3D digital image correlation technique”, *Measurement Science and Technology*, 30(8), 085002 (2019) [Link]

## CONFERENCE PRESENTATIONS

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- Jul 2025* Characterization of local poroelastic swelling near the tip of a propagating crack in a hydrogel  
*The 12<sup>th</sup> European Solid Mechanics Conference (ESMC)* Lyon, France
- Sep 2024* Near crack tip deformation fields reveal the structure of the process zone in brittle hydrogels  
*The 26<sup>th</sup> International Congress in Theoretical and Applied Mechanics (ICTAM)* Daegu, South Korea
- Aug 2024* Near crack tip deformation fields reveal the structure of the process zone in brittle hydrogels (invited)  
*The SES (Society of Engineering) Annual Technical Meeting* Hangzhou, China
- May 2024* Crack tip kinematics reveal the process zone structure in brittle hydrogel fracture  
*The 19<sup>th</sup> European Mechanics of Materials Conferences (EMMC)* Madrid, Spain
- Mar 2024* Evolution of a planar crack perturbed by a rigid inclusion (poster)  
*The 19<sup>th</sup> International Conference on Deformation, Yield and Fracture of Polymers (DYFP)* Kerkrade, Netherlands
- Jul 2022* High-resolution quasistatic near-crack-tip deformation fields in brittle hydrogels  
*The 11<sup>th</sup> European Solid Mechanics Conference (ESMC)* Galway, Ireland
- Oct 2020* New exploration and application of fluorescent digital image correlation  
*The 11<sup>th</sup> International Digital Image Correlation Society Conference (iDICs)* Virtual
- Jan 2020* High-throughput CTE determination of bulk materials based on DSLR and DIC  
*The 26<sup>th</sup> Annual Conference of Beijing Society of Theoretical and Applied Mechanics* Beijing, China

## AWARDS AND HONORS

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- 2020, 2019, 2018 First-Class Academic Scholarship
- 2019 Freshman Merit Scholarship

- 2018 CSC Scholarship for Undergraduate Exchange Program  
2016 Third Prize for the 26<sup>th</sup> “Feng Ru Cup” Competition  
2015 - 2016 Student Research Training Grant

## TEACHING

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- Fall 2022 - 2024* Teaching assistant in Experimental Methods in Engineering Mechanics  
*École Polytechnique Fédérale de Lausanne* *Lausanne, Switzerland*
- Spring 2022 - 2024* Teaching assistant in Continuum Mechanics  
*École Polytechnique Fédérale de Lausanne* *Lausanne, Switzerland*

## SKILLS

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*Programming:* MATLAB, Python, imageJ macro

*Technique:* 3D Particle Tracking, Digital Image Correlation (DIC), Finite Element Analysis

*Laboratory:* Scanning Electron Microscope (SEM), Laser Scanning Confocal Microscope (LSCM), Laser Sheet Fluorescence Microscope (LSFM), Cleanroom, Nanoscribe

*Languages:* Chinese (native), English (proficient)

## SERVICE

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*Journal reviewer:* Experimental Mechanics, Optics Letters, Optics Express, Applied Optics